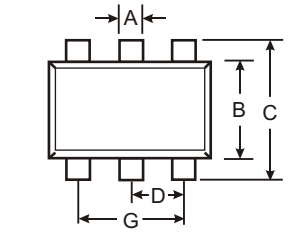
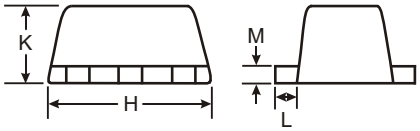
BAS116V

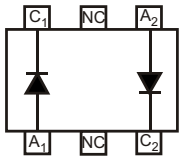
SURFACE MOUNT LOW LEAKAGE DIODE

Features

- Surface Mount Package Ideally Suited for Automatic Insertion
- Very Low Leakage Current
- **Lead Free By Design/RoHS Compliant (Note 1)**







SOT-563			
Dim	**Min**	**Max**	**Typ**
A	0.15	0.30	0.25
B	1.10	1.25	1.20
C	1.55	1.70	1.60
D		0.50	
G	0.90	1.10	1.00
H	1.50	1.70	1.60
K	0.56	0.60	0.60
L	0.10	0.30	0.20
M	0.10	0.18	0.11
All Dimensions in mm			

Mechanical Data

- Case: SOT-563, Molded Plastic
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020C
- Terminal Connections: See Diagram
- Terminals: Finish Matte Tin annealed over Alloy 42 leadframe. Solderable per MIL-STD-202, Method 208
- Marking & Type Code Information: See Last Page
- Ordering Information: See Last Page
- Weight: 0.003 grams (approximate)

Maximum Ratings @ T_A = 25 C unless otherwise specified

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	85	V
RMS Reverse Voltage	$V_{R(RMS)}$	60	V
Forward Continuous Current (Note 2)	I_{FM}	215	mA
Repetitive Peak Forward Current	I_{FRM}	500	mA
Non-Repetitive Peak Forward Surge Current @ t = 1.0 s @ t = 1.0ms @ t = 1.0s	I_{FSM}	4.0 1.0 0.5	A
Operating and Storage Temperature Range	T_j , T_{STG}	-65 to +150	C

Thermal Characteristics @ T_A = 25 C unless otherwise specified

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 2)	P_d	150	mW
Thermal Resistance Junction to Ambient Air (Note 2)	R_{JA}	833	C/W

Electrical Characteristics @ T_A = 25 C unless otherwise specified

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 3)	$V_{(BR)R}$	85			V	I_R = 100 A
Forward Voltage	V_{FM}			0.90 1.0 1.1 1.25	V	I_F = 1.0mA I_F = 10mA I_F = 50mA I_F = 150mA
Leakage Current (Note 3)	I_{RM}			5.0 80	nA nA	V_R = 75V V_R = 75V, T_j = 150 C
Total Capacitance	C_T		2		pF	V_R = 0, f = 1.0MHz
Reverse Recovery Time	t_{rr}			3.0	s	I_F = I_R = 10mA, I_{rr} = 0.1 x I_R, R_L = 100

Note: 1. No purposefully added lead.
2. Part mounted on FR-4 board with recommended pad layout, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.
3. Short duration test pulse used to minimize self-heating effect.

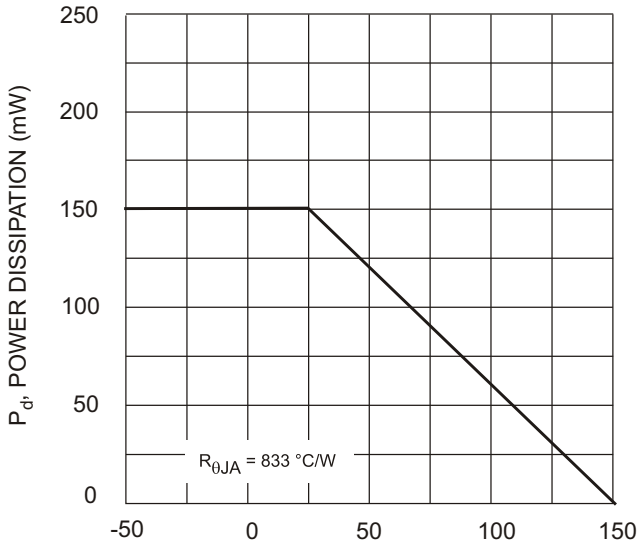


Fig. 1, Derating Curve - Total

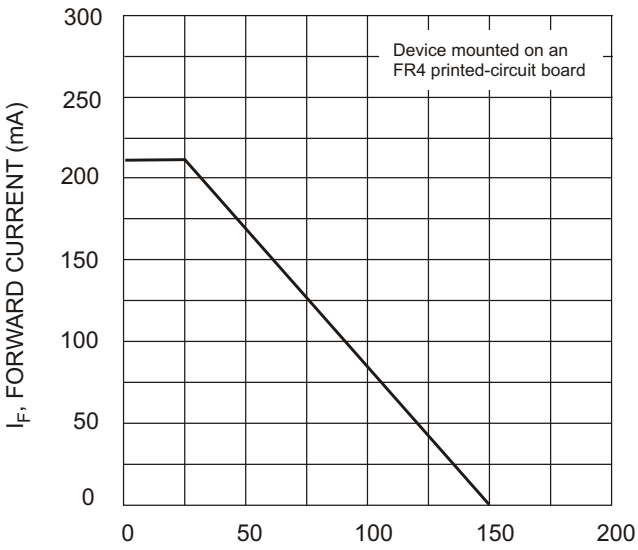


Fig. 2 Current Derating Curve

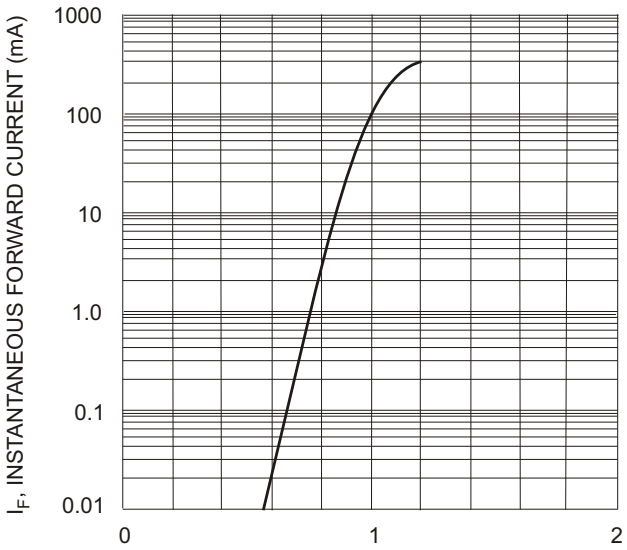


Fig. 3 Typical Forward Characteristics

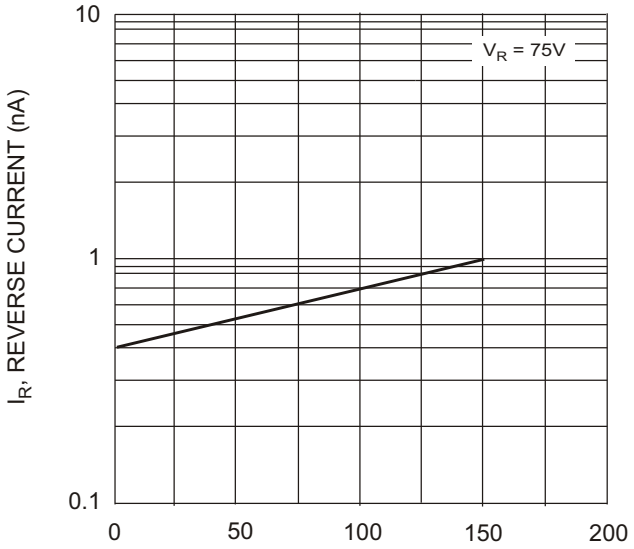


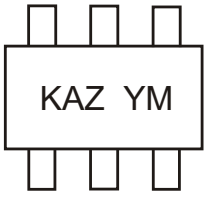
Fig. 4 Typical Reverse Characteristics

Ordering Information (Note 4)

Device	Packaging	Shipping
BAS116V-7	SOT-563	3000/Tape & Reel

Notes: 4. For Packaging Details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

Marking Information



KAZ = Product Type Marking Code (See Page 1 Diagrams)
YM = Date Code Marking
Y = Year (ex: R = 2004)
M = Month (ex: 9 = September)

Date Code Key

Year	2004	2005	2006	2007	2008	2009	2010	2011	2012
Code	R	S	T	U	V	W	X	Y	Z

Month	Jan	Feb	March	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D

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